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Details

Product Status	Obsolete
Core Processor	H8S/2600
Core Size	16-Bit
Speed	25MHz
Connectivity	I ² C, IrDA, SCI, SmartCard
Peripherals	DMA, POR, PWM, WDT
Number of I/O	73
Program Memory Size	256KB (256K x 8)
Program Memory Type	FLASH
EEPROM Size	-
RAM Size	16K x 8
Voltage - Supply (Vcc/Vdd)	3V ~ 3.6V
Data Converters	A/D 16x10b; D/A 4x8b
Oscillator Type	Internal
Operating Temperature	-20°C ~ 75°C (TA)
Mounting Type	Surface Mount
Package / Case	120-TQFP
Supplier Device Package	120-TQFP (14x14)
Purchase URL	https://www.e-xfl.com/product-detail/renesas-electronics-america/df2633te25v

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Figure 24.1 (b) Mode Transition Diagram (H8S/2695)	1020	Figure amended
24.8.3 Notes	1041	Description amended (2) Current Consumption when Waiting for Oscillation Stabilization The current consumption increases during stabilization of oscillation.
24.10.3 Usage Notes	—	Description deleted
24.13 Usage Notes	1046	Newly added

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Pin No.		Pin Name			
TFP-120	FP-128B	Mode 4	Mode 5	Mode 6	Mode 7
24	28	PA3/A19/SCK2	PA3/A19/SCK2	PA3/A19/SCK2	PA3/SCK2
25	29	VSS	VSS	VSS	VSS
26	30	P10/PO8/TIOCA0/ DACK0/A20	P10/PO8/TIOCA0/ DACK0/A20	P10/PO8/TIOCA0/ DACK0/A20	P10/PO8/TIOCA0/ DACK0
27	31	P11/PO9/TIOCB0/ DACK1/A21	P11/PO9/TIOCB0/ DACK1/A21	P11/PO9/TIOCB0/ DACK1/A21	P11/PO9/TIOCB0/ DACK1
28	32	P12/PO10/TIOCC0/ TCLKA/A22	P12/PO10/TIOCC0/ TCLKA/A22	P12/PO10/TIOCC0/ TCLKA/A22	P12/PO10/TIOCC0/ TCLKA
29	33	P13/PO11/TIOCD0/ TCLKB/A23	P13/PO11/TIOCD0/ TCLKB/A23	P13/PO11/TIOCD0/ TCLKB/A23	P13/PO11/TIOCD0/ TCLKB
30	34	P14/PO12/TIOCA1/ IRQ0	P14/PO12/TIOCA1/ IRQ0	P14/PO12/TIOCA1/ IRQ0	P14/PO12/TIOCA1/ IRQ0
—	35	NC*1	NC*1	NC*1	NC*1
—	36	NC*1	NC*1	NC*1	NC*1
31	37	P15/PO13/TIOCB1/ TCLKC	P15/PO13/TIOCB1/ TCLKC	P15/PO13/TIOCB1/ TCLKC	P15/PO13/TIOCB1/ TCLKC
32	38	P16/PO14/TIOCA2/ PWM2/IRQ1	P16/PO14/TIOCA2/ PWM2/IRQ1	P16/PO14/TIOCA2/ PWM2/IRQ1	P16/PO14/TIOCA2/ PWM2/IRQ1
33	39	P17/PO15/TIOCB2/ PWM3/TCLKD	P17/PO15/TIOCB2/ PWM3/TCLKD	P17/PO15/TIOCB2/ PWM3/TCLKD	P17/PO15/TIOCB2/ PWM3/TCLKD
34	40	PE0/D0	PE0/D0	PE0/D0	PE0
35	41	PE1/D1	PE1/D1	PE1/D1	PE1
36	42	PE2/D2	PE2/D2	PE2/D2	PE2
37	43	PE3/D3	PE3/D3	PE3/D3	PE3
38	44	PE4/D4	PE4/D4	PE4/D4	PE4
39	45	PE5/D5	PE5/D5	PE5/D5	PE5
40	46	PE6/D6	PE6/D6	PE6/D6	PE6
41	47	PE7/D7	PE7/D7	PE7/D7	PE7
42	48	VSS	VSS	VSS	VSS
43	49	D8	D8	D8	PD0
44	50	PVCC1	PVCC1	PVCC1	PVCC1
45	51	D9	D9	D9	PD1
46	52	D10	D10	D10	PD2
47	53	D11	D11	D11	PD3

Channel	Bit 7	Bit 6	Bit 5	Bit 4	Description		
	IOB3	IOB2	IOB1	IOB0			
1	0	0	0	0	TGR1B	Output disabled	(Initial value)
				1	is output	Initial output is 0	0 output at compare match
				1	compare	output	1 output at compare match
				0	register		Toggle output at compare match
				1			
				1			
	1	0	0	0	TGR1B	Output disabled	
				1	is input	Initial output is 1	0 output at compare match
				1	capture	output	1 output at compare match
				0	register		Toggle output at compare match
				1			
				1			
1	0	0	0	0	TGR1B	Capture input	Input capture at rising edge
				1	is input	source is	Input capture at falling edge
				1	capture	TIOCB1 pin	Input capture at both edges
				*	register		
				*		Capture input	Input capture at generation of
				*		source is TGR0C	TGR0C compare match/input
						compare match/ input capture	capture

*: Don't care

Channel	Bit 7	Bit 6	Bit 5	Bit 4	Description		
	IOB3	IOB2	IOB1	IOB0			
2	0	0	0	0	TGR2B	Output disabled	(Initial value)
				1	is output	Initial output is 0	0 output at compare match
				1	compare	output	1 output at compare match
				0	register		Toggle output at compare match
				1			
				1			
	1	0	0	0	TGR2B	Output disabled	
				1	is input	Initial output is 1	0 output at compare match
				1	capture	output	1 output at compare match
				0	register		Toggle output at compare match
				1			
				1			
1	*	0	0	0	TGR2B	Capture input	Input capture at rising edge
				1	is input	source is	Input capture at falling edge
				*	capture	TIOCB2 pin	Input capture at both edges
				*	register		

*: Don't care

Contention between TGR Write and Input Capture: If the input capture signal is generated in the T2 state of a TGR write cycle, the input capture operation takes precedence and the write to TGR is not performed.

Figure 11.54 shows the timing in this case.

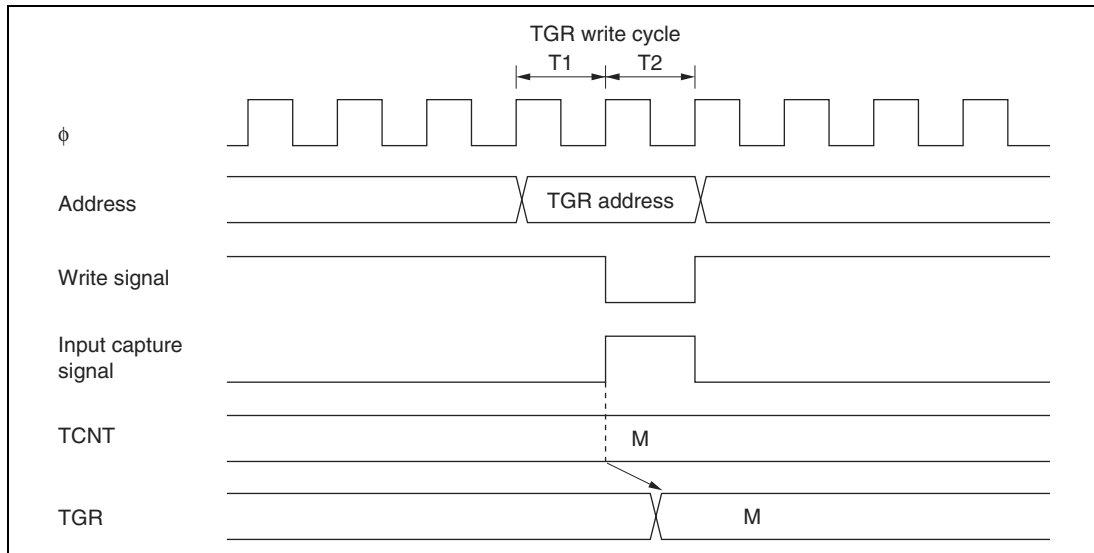


Figure 11.54 Contention between TGR Write and Input Capture

NDERL Bits 7 to 0—Next Data Enable 7 to 0 (NDER7 to NDER0): These bits enable or disable pulse output on a bit-by-bit basis. However, the H8S/2633 Group has no output pins corresponding to NDERL.

Bits 7 to 0

NDER7 to NDER0	Description
0	Pulse outputs PO7 to PO0 are disabled (NDR7 to NDR0 are not transferred to POD7 to POD0) (Initial value)
1	Pulse outputs PO7 to PO0 are enabled (NDR7 to NDR0 are transferred to POD7 to POD0)

12.2.2 Output Data Registers H and L (PODRH, PODRL)

PODRH

Bit	:	7	6	5	4	3	2	1	0
		POD15	POD14	POD13	POD12	POD11	POD10	POD9	POD8
Initial value :		0	0	0	0	0	0	0	0
R/W	:	R/(W)*	R/(W)*	R/(W)*	R/(W)*	R/(W)*	R/(W)*	R/(W)*	R/(W)*

PODRL

Bit	:	7	6	5	4	3	2	1	0
		POD7	POD6	POD5	POD4	POD3	POD2	POD1	POD0
Initial value :		0	0	0	0	0	0	0	0
R/W	:	R/(W)*	R/(W)*	R/(W)*	R/(W)*	R/(W)*	R/(W)*	R/(W)*	R/(W)*

Note: * A bit that has been set for pulse output by NDER is read-only.

PODRH and PODRL are 8-bit readable/writable registers that store output data for use in pulse output. However, the H8S/2633 Group has no pins corresponding to PODRL.

Table 16.5 shows the maximum bit rate for each frequency in asynchronous mode. Tables 16.6 and 16.7 show the maximum bit rates with external clock input.

Table 16.5 Maximum Bit Rate for Each Frequency (Asynchronous Mode)

ϕ (MHz)	Maximum Bit Rate (bit/s)	n	N
2	62500	0	0
2.097152	65536	0	0
2.4576	76800	0	0
3	93750	0	0
3.6864	115200	0	0
4	125000	0	0
4.9152	153600	0	0
5	156250	0	0
6	187500	0	0
6.144	192000	0	0
7.3728	230400	0	0
8	250000	0	0
9.8304	307200	0	0
10	312500	0	0
12	375000	0	0
12.288	384000	0	0
14	437500	0	0
14.7456	460800	0	0
16	500000	0	0
17.2032	537600	0	0
18	562500	0	0
19.6608	614400	0	0
20	625000	0	0
25	781250	0	0
28	875000	0	0

In serial reception, the SCI operates as described below.

[1] The SCI monitors the transmission line, and if a 0 stop bit is detected, performs internal synchronization and starts reception.

[2] The received data is stored in RSR in LSB-to-MSB order.

[3] The parity bit and stop bit are received.

After receiving these bits, the SCI carries out the following checks.

[a] Parity check:

The SCI checks whether the number of 1 bits in the receive data agrees with the parity (even or odd) set in the O/E bit in SMR.

[b] Stop bit check:

The SCI checks whether the stop bit is 1.

If there are two stop bits, only the first is checked.

[c] Status check:

The SCI checks whether the RDRF flag is 0, indicating that the receive data can be transferred from RSR to RDR.

If all the above checks are passed, the RDRF flag is set to 1, and the receive data is stored in RDR.

If a receive error* is detected in the error check, the operation is as shown in table 16.11.

Note: * Subsequent receive operations cannot be performed when a receive error has occurred.

Also note that the RDRF flag is not set to 1 in reception, and so the error flags must be cleared to 0.

[4] If the RIE bit in SCR is set to 1 when the RDRF flag changes to 1, a receive data full interrupt (RXI) request is generated.

Also, if the RIE bit in SCR is set to 1 when the ORER, PER, or FER flag changes to 1, a receive error interrupt (ERI) request is generated.

As per the standard, the High pulse width is a minimum of 1.41 μs , the maximum is $(3/16 + 2.5\%) \times \text{bit rate}$, or $(3/16 \times \text{bit rate}) + 1.08 \mu\text{s}$. With a 20MHz system clock ϕ , the minimum High pulse width can be set to 1.6 μs , which is greater than the 1.41 μs required by the standard.

When the value of the serial data is “1”, no pulse is output.

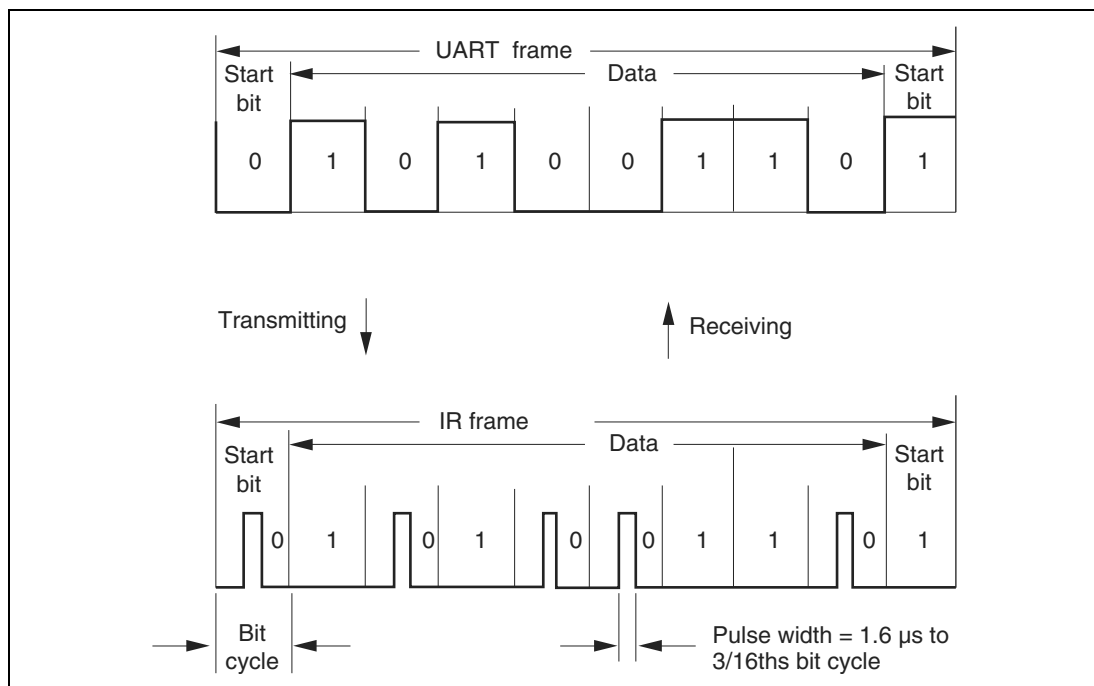


Figure 16.22 IrDA Transmit and Receive Operations

(2) Receiving

When receiving, the IR frame data is converted into UART frames by the IrDA interface and input to the SCI.

When a High pulse is detected, “0” is output. If there is no pulse for the duration of 1 bit, “1” is output. Pulses of less than the minimum pulse width of 1.41 μs are also recognized as “0” data.

(3) Selecting High Pulse Width

Table 16.12 shows the settings of IrCKS2 to IrCKS0 (for the minimum pulse width), at various LSI operating frequencies, and various bit rates to set the pulse width when transmitting with a pulse width less than 3/16ths of the bit rate.

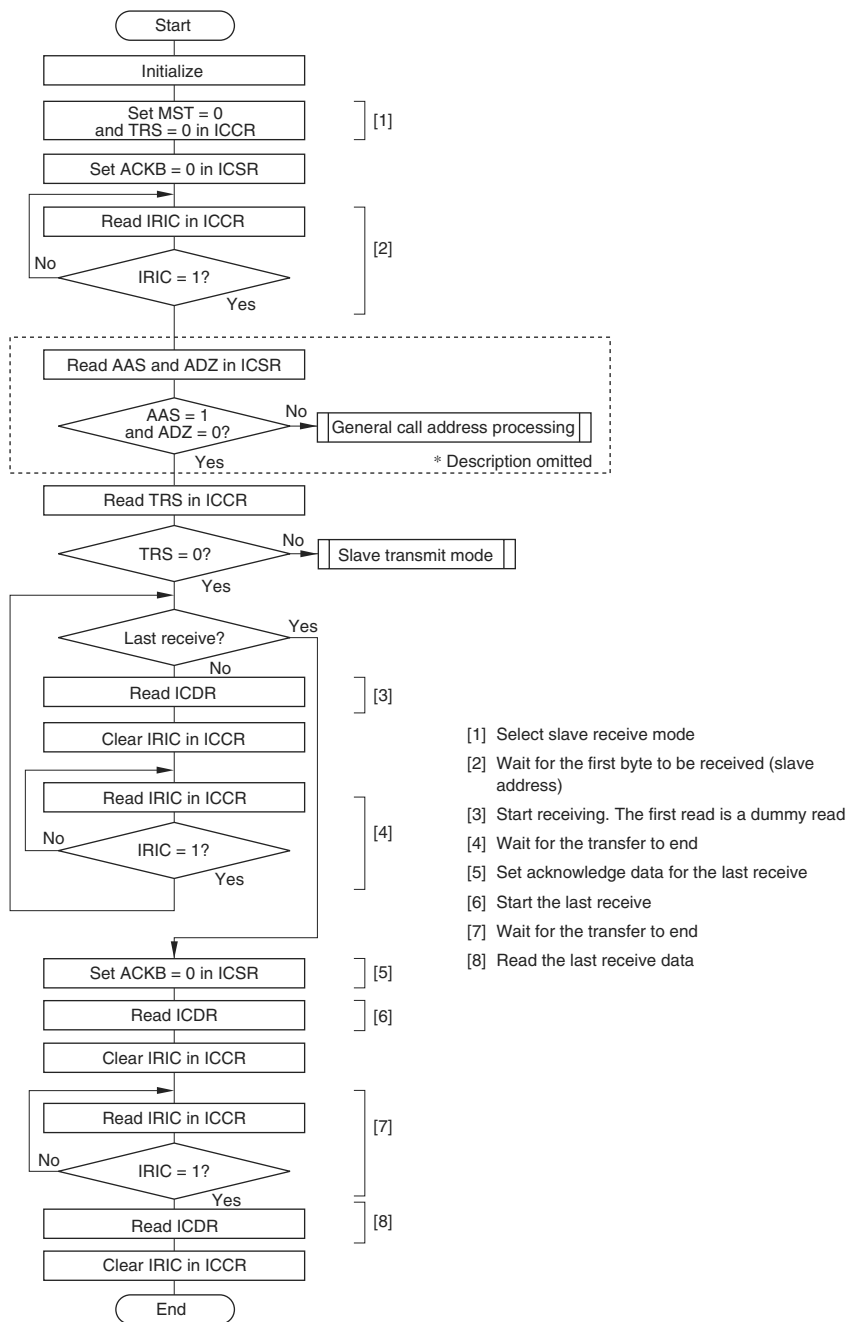


Figure 18.14 Flowchart for Slave Receive Mode (Example)

19.4.3 Input Sampling and A/D Conversion Time

The A/D converter has a built-in sample-and-hold circuit. The A/D converter samples the analog input at a time t_D after the ADST bit is set to 1, then starts conversion. Figure 19.5 shows the A/D conversion timing. Table 19.4 indicates the A/D conversion time.

As indicated in figure 19.5, the A/D conversion time includes t_D and the input sampling time. The length of t_D varies depending on the timing of the write access to ADCSR. The total conversion time therefore varies within the ranges indicated in table 19.4.

In scan mode, the values given in table 19.4 apply to the first conversion time. The values given in table 19.5 apply to the second and subsequent conversions. In both cases, set bits CKS1 and CKS0 in ADCR to give a conversion time of at least 10 μs when $AV_{CC} \geq 4.5\text{ V}$, and at least 16 μs when $AV_{CC} < 4.5\text{ V}$.

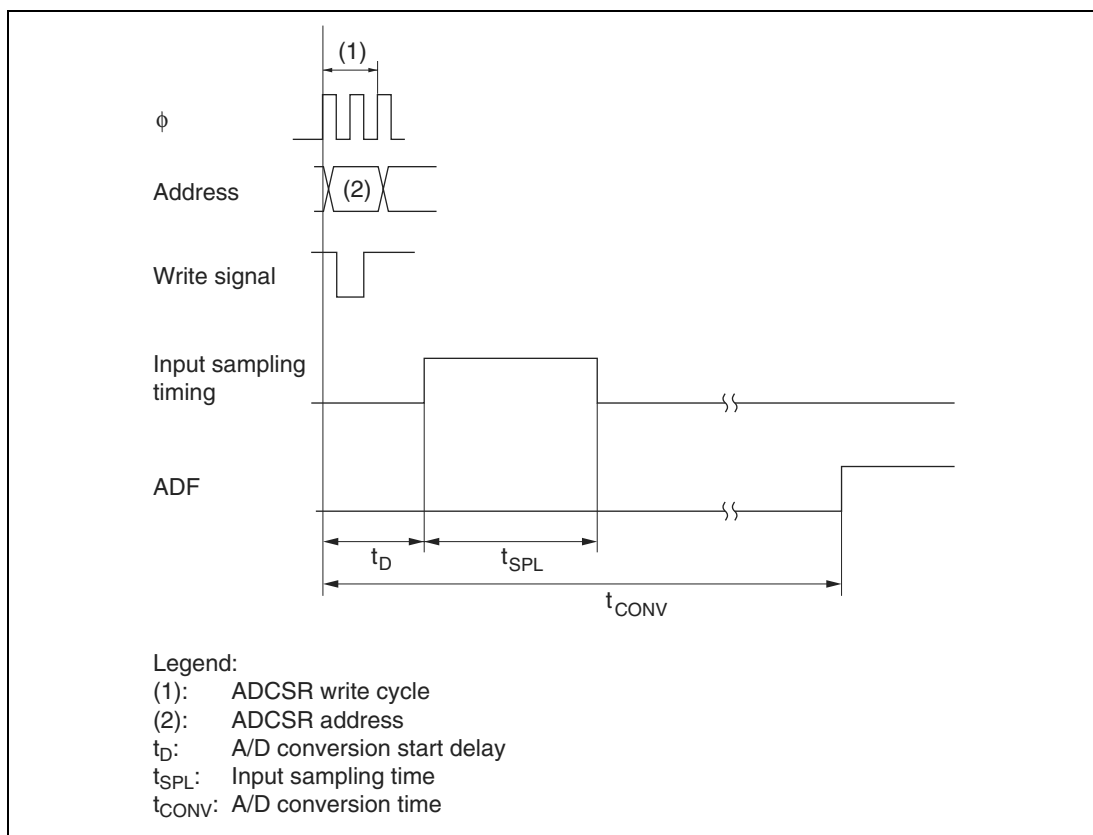


Figure 19.5 A/D Conversion Timing

Bits 1 and 0—Frequency Multiplication Factor (STC1, STC0): The STC bits specify the frequency multiplication factor of the PLL circuit.

Bit 1	Bit 0	Description
STC1	STC0	
0	0	×1 (Initial value)
	1	×2
1	0	×4
	1	Setting prohibited

Note: A system clock frequency multiplied by the multiplication factor (STC1 and STC0) should not exceed the maximum operating frequency defined in sections 26 and 27, Electrical Characteristics.

Current consumption and noise can be reduced by using this function's PLL ×4 setting and lowering the external clock frequency.

The input clock frequency is 2 MHz to 25 MHz. With the H8S/2633R and H8S/2695 PLL must be set to use a multiplier of × 2 or × 4 when operating at frequencies of $25 \text{ MHz} < \phi \leq 28 \text{ MHz}$.

23B.3 Oscillator

Clock pulses can be supplied by connecting a crystal resonator, or by input of an external clock.

23B.3.1 Connecting a Crystal Resonator

Circuit Configuration: A crystal resonator can be connected as shown in the example in figure 23B.2. Select the damping resistance R_d according to table 23B.2. An AT-cut parallel-resonance crystal should be used.

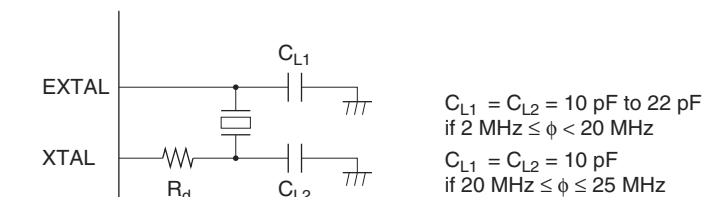


Figure 23B.2 Connection of Crystal Resonator (Example)

26.4 A/D Conversion Characteristics

Table 26.11 lists the A/D conversion characteristics.

Table 26.11 A/D Conversion Characteristics

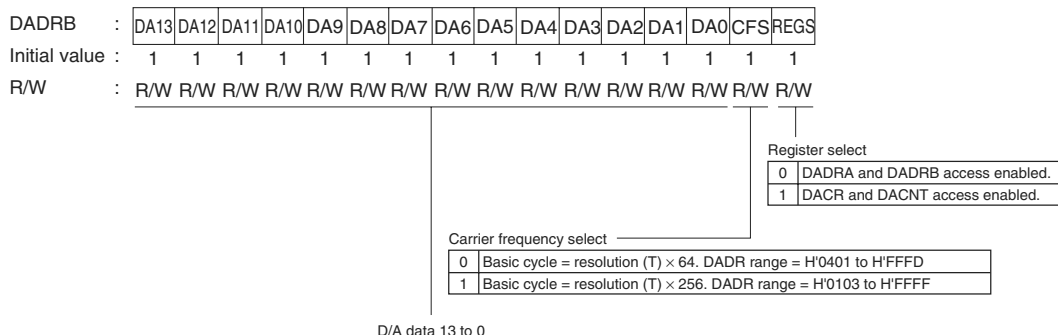
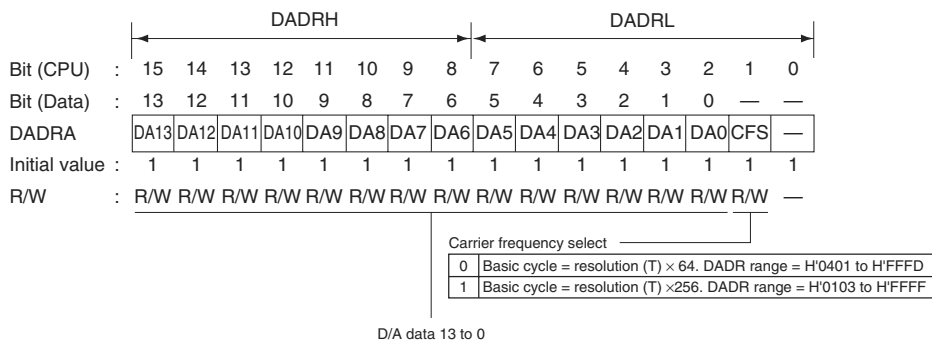
Conditions: $PV_{CC} = 4.5\text{ V to }5.5\text{ V}$, $AV_{CC} = 4.5\text{ V to }5.5\text{ V}$, $V_{ref} = 4.5\text{ V to }AV_{CC}$,
 $V_{SS} = AV_{SS} = PLLV_{SS} = 0\text{ V}$, $\phi = 2\text{ to }28\text{ MHz}$, $T_a = -20^\circ\text{C to }+75^\circ\text{C}$ (regular
specifications), $T_a = -40^\circ\text{C to }+85^\circ\text{C}$ (wide-range specifications)

Item	Min	Typ	Max	Unit
Resolution	10	10	10	bits
Conversion time	10	—	—	μs
Analog input capacitance	—	—	20	pF
Permissible signal-source impedance	—	—	5	$k\Omega$
Nonlinearity error	—	—	± 3.5	LSB
Offset error	—	—	± 3.5	LSB
Full-scale error	—	—	± 3.5	LSB
Quantization	—	± 0.5	—	LSB
Absolute accuracy	—	—	± 4.0	LSB

Instruc- tion	Mnemonic	Size	Instruction Format									
			1st byte	2nd byte	3rd byte	4th byte	5th byte	6th byte	7th byte	8th byte	9th byte	10th byte
ROTR	ROTR.B Rd	B	1 3	8 rd								
	ROTR.B #2, Rd	B	1 3	C rd								
	ROTR.W Rd	W	1 3	9 rd								
	ROTR.W #2, Rd	W	1 3	D rd								
	ROTR.L ERd	L	1 3	B 0 erd								
	ROTR.L #2, ERd	L	1 3	F 0 erd								
ROTXL	ROTXL.B Rd	B	1 2	0 rd								
	ROTXL.B #2, Rd	B	1 2	4 rd								
	ROTXL.W Rd	W	1 2	1 rd								
	ROTXL.W #2, Rd	W	1 2	5 rd								
	ROTXL.L ERd	L	1 2	3 0 erd								
	ROTXL.L #2, ERd	L	1 2	7 0 erd								
ROTXR	ROTXR.B Rd	B	1 3	0 rd								
	ROTXR.B #2, Rd	B	1 3	4 rd								
	ROTXR.W Rd	W	1 3	1 rd								
	ROTXR.W #2, Rd	W	1 3	5 rd								
	ROTXR.L ERd	L	1 3	3 0 erd								
	ROTXR.L #2, ERd	L	1 3	7 0 erd								
RTE	RTE	—	5 6	7 0								
RTS	RTS	—	5 4	7 0								
SHAL	SHAL.B Rd	B	1 0	8 rd								
	SHAL.B #2, Rd	B	1 0	C rd								
	SHAL.W Rd	W	1 0	9 rd								
	SHAL.W #2, Rd	W	1 0	D rd								
	SHAL.L ERd	L	1 0	B 0 erd								
	SHAL.L #2, ERd	L	1 0	F 0 erd								

Instruc- tion	Mnemonic	Size	Instruction Format									
			1st byte	2nd byte	3rd byte	4th byte	5th byte	6th byte	7th byte	8th byte	9th byte	10th byte
SHAR	SHAR.B Rd	B	1	8	rd							
	SHAR.B #2, Rd	B	1	1	C	rd						
	SHAR.W Rd	W	1	1	9	rd						
	SHAR.W #2, Rd	W	1	1	D	rd						
	SHAR.L ERd	L	1	1	B	0:erd						
	SHAR.L #2, ERd	L	1	1	F	0:erd						
SHLL	SHLL.B Rd	B	1	0	0	rd						
	SHLL.B #2, Rd	B	1	0	4	rd						
	SHLL.W Rd	W	1	0	1	rd						
	SHLL.W #2, Rd	W	1	0	5	rd						
	SHLL.L ERd	L	1	0	3	0:erd						
	SHLL.L #2, ERd	L	1	0	7	0:erd						
SHLR	SHLR.B Rd	B	1	1	0	rd						
	SHLR.B #2, Rd	B	1	1	4	rd						
	SHLR.W Rd	W	1	1	1	rd						
	SHLR.W #2, Rd	W	1	1	5	rd						
	SHLR.L ERd	L	1	1	3	0:erd						
	SHLR.L #2, ERd	L	1	1	7	0:erd						
SLEEP	SLEEP	—	0	1	8	0						
STC	STC.B CCR,Rd	B	0	2	0	rd						
	STC.B EXR,Rd	B	0	2	1	rd						
	STC.W CCR,@ERd	W	0	1	4	0	6	9	1:erd	0		
	STC.W EXR,@ERd	W	0	1	4	1	6	9	1:erd	0		
	STC.W CCR,@(d:16,ERd)	W	0	1	4	0	6	F	1:erd	0		
	STC.W EXR,@(d:16,ERd)	W	0	1	4	1	6	F	1:erd	0		
	STC.W CCR,@(d:32,ERd)	W	0	1	4	0	7	8	0:erd	0	6	A
	STC.W EXR,@(d:32,ERd)	W	0	1	4	1	7	8	0:erd	0	6	A
	STC.W CCR,@ERd	W	0	1	4	0	6	D	1:erd	0		
	STC.W EXR,@ERd	W	0	1	4	1	6	D	1:erd	0		

DADRAH0—PWM (D/A) Data Register AH0	H'FDB8	PWM0
DADRAL0—PWM (D/A) Data Register AL0	H'FDB9	PWM0
DADRBH0—PWM (D/A) Data Register BH0	H'FDBA	PWM0
DADRBL0—PWM (D/A) Data Register BL0	H'FDBB	PWM0
DADRAH1—PWM (D/A) Data Register AH1	H'FDBC	PWM1
DADRAL1—PWM (D/A) Data Register AL1	H'FDBD	PWM1
DADRBH1—PWM (D/A) Data Register BH1	H'FDBE	PWM1
DADRBL1—PWM (D/A) Data Register BL1	H'FDBF	PWM1



NDERH—Next Data Enable Register H**H'FE28****PPG****NDERL—Next Data Enable Register L****H'FE29****PPG****NDERH**

Bit	:	7	6	5	4	3	2	1	0
		NDER15	NDER14	NDER13	NDER12	NDER11	NDER10	NDER9	NDER8
Initial value	:	0	0	0	0	0	0	0	0
R/W	:	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W

Next data enable 15 to 8 _____

NDER15 to NDER8	
0	Pulse output PO15 to PO8 disabled (transfer from NDR15-NDR8 to POD15-POD8 disabled).
1	Pulse output PO15 to PO8 enabled (transfer from NDR15-NDR8 to POD15-POD8 enabled).

NDERL

Bit	:	7	6	5	4	3	2	1	0
		NDER7	NDER6	NDER5	NDER4	NDER3	NDER2	NDER1	NDER0
Initial value	:	0	0	0	0	0	0	0	0
R/W	:	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W

Next data enable 7 to 0 _____

NDER7 to NDER0	
0	Pulse output PO7 to PO0 disabled (transfer from NDR7-NDR0 to POD7-POD0 disabled).
1	Pulse output PO7 to PO0 enabled (transfer from NDR7-NDR0 to POD7-POD0 enabled).

Short address mode

Bit	7	6	5	4	3	2	1	0
DMACR	DTSZ	DTID	RPE	DTDIR	DTF3	DTF2	DTF1	DTF0
Initial value	0	0	0	0	0	0	0	0
Read/Write	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W

Data Transfer Size

0	Byte-size transfer
1	Word-size transfer

Data Transfer Increment/Decrement

0	MAR is incremented after a data transfer - When DTSZ = 0, MAR is incremented by 1 after a transfer - When DTSZ = 1, MAR is incremented by 2 after a transfer
1	MAR is decremented after a data transfer - When DTSZ = 0, MAR is decremented by 1 after a transfer - When DTSZ = 1, MAR is decremented by 2 after a transfer

Data Transfer Factor

				Channel A	Channel B
0	0	0	0	—	
			1	Activated by A/D converter conversion end interrupt	
	1	0	—		Activated by DREQ pin falling edge input
			1		Activated by DREQ pin low-level input
1	0	0	0	Activated by SCI channel 0 transmit-data-empty interrupt	
			1	Activated by SCI channel 0 reception complete interrupt	
	1	0	0	Activated by SCI channel 1 transmit-data-empty interrupt	
			1	Activated by SCI channel 1 reception complete interrupt	
1	0	0	0	Activated by TPU channel 0 compare match/input capture A interrupt	
			1	Activated by TPU channel 1 compare match/input capture A interrupt	
	1	0	0	Activated by TPU channel 2 compare match/input capture A interrupt	
			1	Activated by TPU channel 3 compare match/input capture A interrupt	
	1	0	0	Activated by TPU channel 4 compare match/input capture A interrupt	
			1	Activated by TPU channel 5 compare match/input capture A interrupt	
1	0	—	—		
			1		

Data Transfer Direction

DMABCR	Bit 4	Description
SAE	DTDIR	
0	0	Transfer with MAR as source address and IOAR as destination address (initial value)
	1	Transfer with IOAR as source address and MAR as destination address
1	0	Transfer with MAR as source address and $\overline{\text{DACK}}$ pin as write strobe
	1	Transfer with $\overline{\text{DACK}}$ pin as read strobe and MAR as destination address

Repeat Enable

Bit 5	DMABCR	Description
RPE	DTIE	
0	0	Transfer in sequential mode (no transfer end interrupt) (initial value)
	1	Transfer in sequential mode (with transfer end interrupt)
1	0	Transfer in repeat mode (no transfer end interrupt)
	1	Transfer in idle mode (with transfer end interrupt)

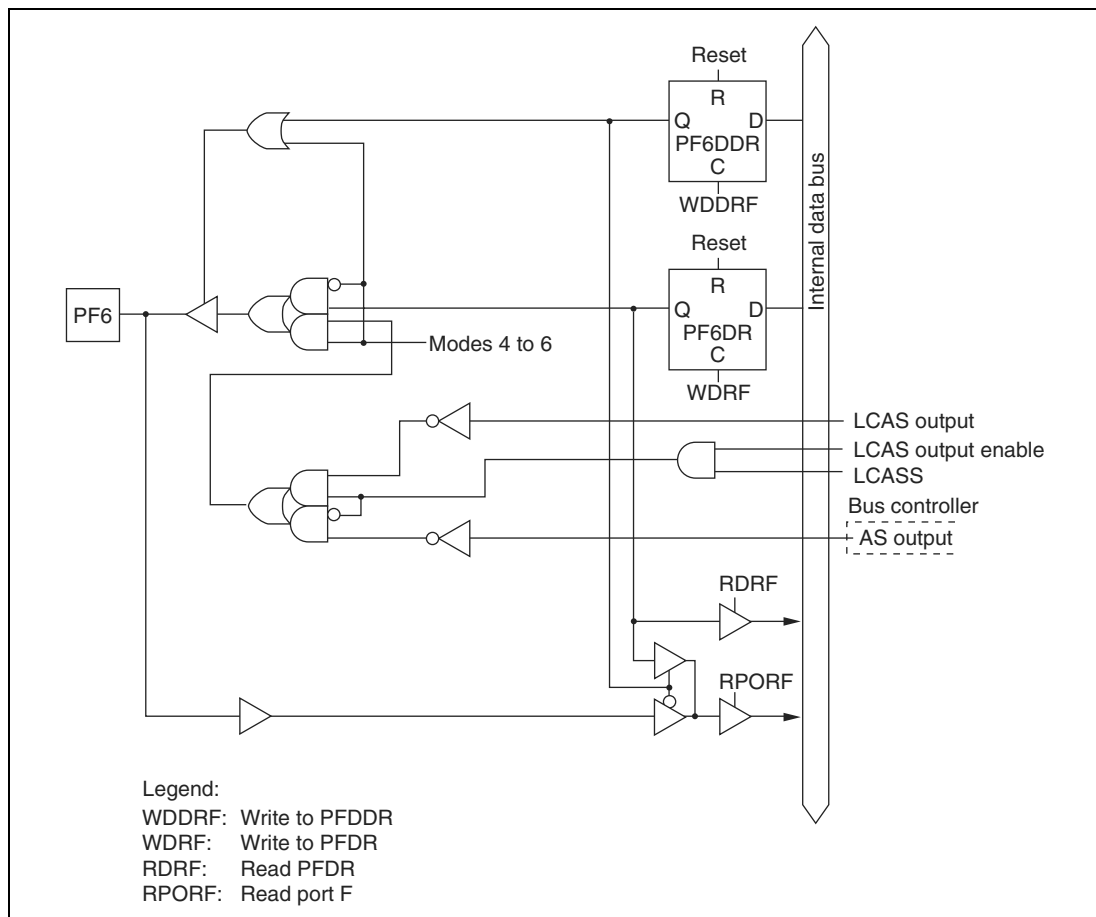


Figure C.11 (g) Port F Block Diagram (Pin PF6)

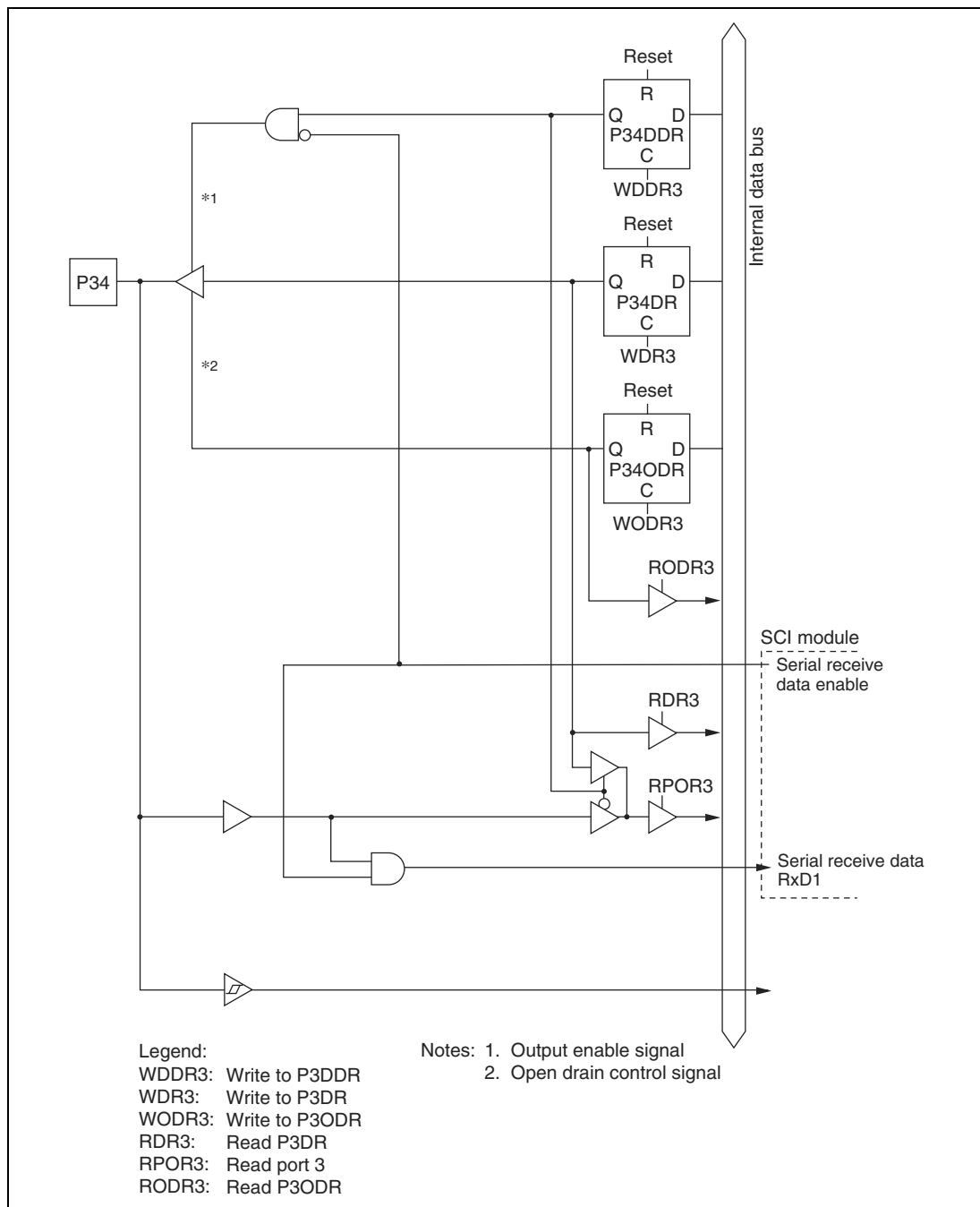


Figure C.14 (e) Port 3 Block Diagram (Pin P34)